

STL8N65M5

N-channel 650 V, 0.56 Ω, 7 A MDmesh[™] V Power MOSFET in PowerFLAT[™] 5x5

Features

Order code	V _{DSS} @ T _{Jmax}	R _{DS(on)} max	I _D
STL8N65M5	710 V	< 0.6 Ω	7 A ⁽¹⁾

- 1. The value is rated according to Rthj-case
- Worldwide best R_{DS(on)} * area
- Higher V_{DSS} rating
- High dv/dt capability
- Excellent switching performance
- Easy to drive
- 100% avalanche tested

Applications

■ Switching applications

Description

This device is an N-channel MDmesh™ V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

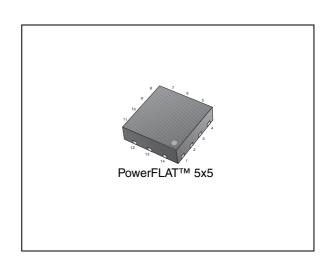


Figure 1. Internal schematic diagram

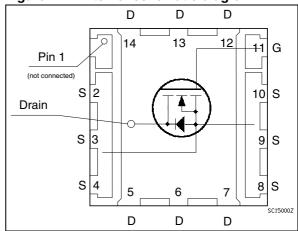


Table 1. Device summary

Order code	Marking	Package	Packaging
STL8N65M5	8N65M5	PowerFLAT™ 5x5	Tape and reel

Contents STL8N65M5

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STL8N65M5 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	650	V
V _{GS}	Gate-source voltage	± 25	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	7	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	4.4	Α
I _D ⁽²⁾	Drain current (continuous) at T _{amb} = 25 °C	1.4	Α
I _D ⁽²⁾	Drain current (continuous) at T _{amb} = 100 °C	0.6	Α
I _{DM} ^{(2),(3)}	Drain current (pulsed)	5.6	Α
P _{TOT} (2)	Total dissipation at T _{amb} = 25 °C	2.5	W
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25 °C	70	W
I _{AR}	Avalanche current, repetitive or not- repetitive (pulse width limited by T _j max)	2	А
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	120	mJ
dv/dt (4)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} The value is rated according to $R_{\mbox{\scriptsize thj-case}}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.78	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb max	60	°C/W

^{1.} When mounted on 1inch² FR-4 board, 2 oz Cu

^{2.} When mounted on FR-4 board of inch², 2oz Cu

^{3.} Pulse with limited by safe operating area.

^{4.} $I_{SD} \leq$ 7 A, di/dt \leq 400 A/ μ s, V_{Peak} < $V_{(BR)DSS}$, V_{DD} = 400 V.

Electrical characteristics STL8N65M5

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 1 mA	650			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 650 V V _{DS} = 650 V, T _C =125 °C			1 100	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 3.5 A		0.56	0.6	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	690 18 2	-	pF pF pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 520 V, V _{GS} = 0	-	17	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	1 V _{DS} = 0 to 520 V, V _{GS} = 0	-	52	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz open drain	-	2.4	-	Ω
Qg	Total gate charge	V _{DD} = 520 V, I _D = 3.5 A,		15		nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	3.6	-	nC
Q_{gd}	Gate-drain charge	(see Figure 15)		6		nC

C_{oss eq.} time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

^{2.} $C_{oss\ eq.}$ energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(off)}	Turn-off delay time	$V_{DD} = 400 \text{ V}, I_{D} = 4 \text{ A},$		50		ns
t _{r (V)}	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$		14		ns
t _{c(off)}	Cross time	(see Figure 16),	-	20	_	ns
t _{f (i)}	Fall time	(see Figure 19)		11		ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)		-		7 28	A A
V _{SD} (2)	Forward on voltage	I _{SD} = 7 A, V _{GS} = 0	-		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} = 7A, di/dt = 100 A/μs V _{DD} = 100 V (see <i>Figure 16</i>)	1	200 1.6 16		ns μC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 7 \text{ A, di/dt} = 100 \text{ A/µs}$ $V_{DD} = 100 \text{ V, T}_{j} = 150 \text{ °C}$ (see <i>Figure 16</i>)		263 1.9 15		ns μC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STL8N65M5

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

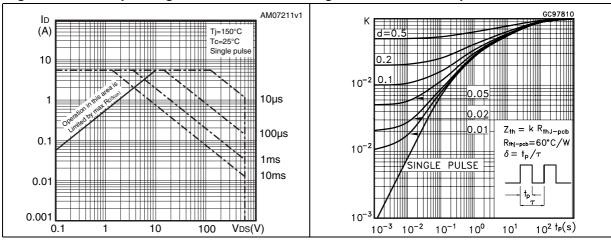


Figure 4. Output characteristics

Figure 5. Transfer characteristics

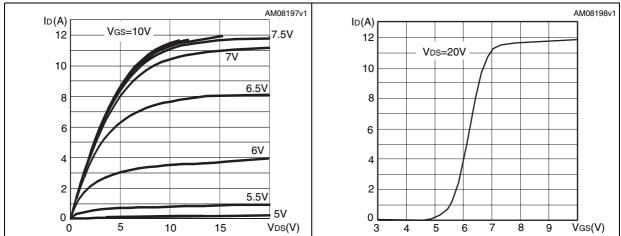


Figure 6. Gate charge vs gate-source voltage Figure 7. Static drain-source on resistance

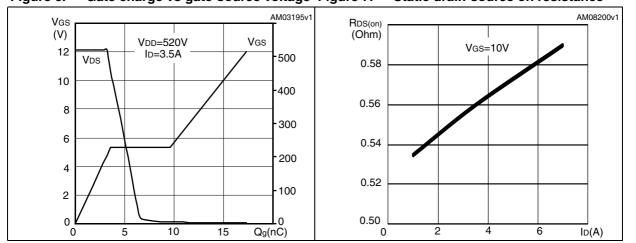
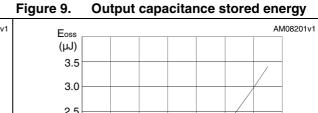
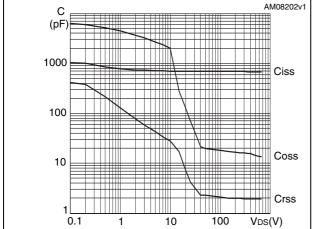


Figure 8. **Capacitance variations**

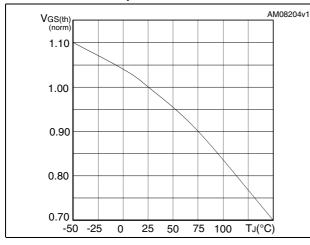


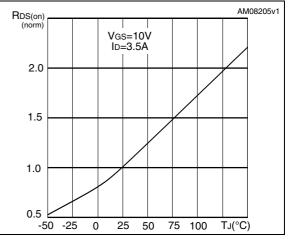


2.5 2.0 1.5 1.0 0.5 100 200 300 400 500 600 V_{DS}(V)

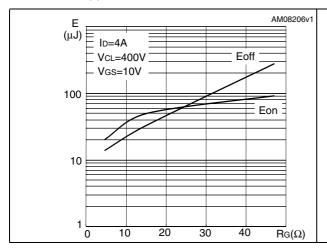
vs temperature

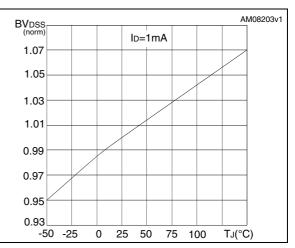
Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs temperature





Switching losses vs gate resistance Figure 13. Normalized B_{VDSS} vs temperature Figure 12.





1. Eon including reverse recovery of a SiC diode

Test circuits STL8N65M5

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

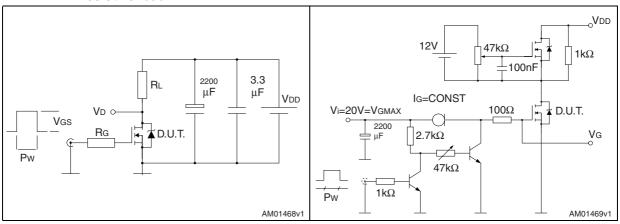


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

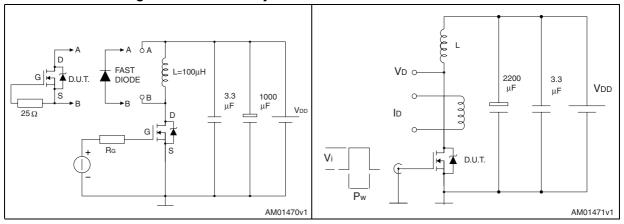
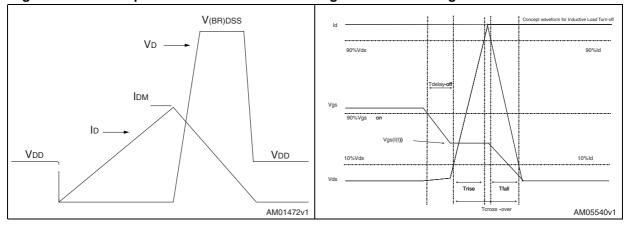


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



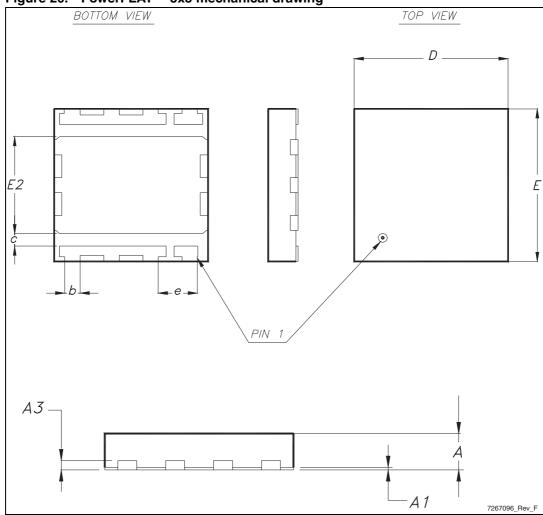
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. PowerFLAT™ 5x5 mechanical dimensions

Dim.	mm				
Dilli.	Min.	Тур.	Max.		
А	0.80	0.90	1.0		
A1	0	0.02	0.05		
A3		0.24			
D	4.90	5.0	5.10		
E	4.90	5.0	5.10		
E2	2.49	2.57	2.64		
е	1.22	1.27	1.32		
b	0.43	0.51	0.58		
С	0.64	0.71	0.79		

Figure 20. PowerFLAT™ 5x5 mechanical drawing



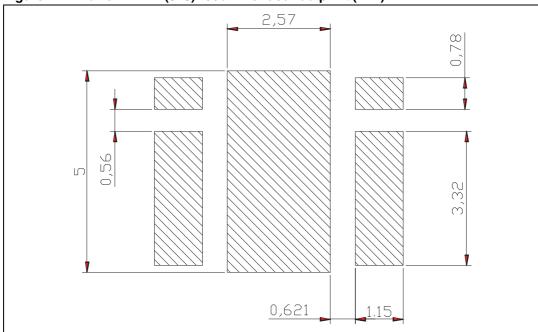


Figure 21. PowerFLAT™(5x5) recommended footprint (mm)

Revision history STL8N65M5

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
05-Jul-2011	1	First release
07-Jul-2011	2	Updated Figure 1.
08-Aug-2011	3	Updated <i>Figure 3: Thermal impedance</i> . and R _{thj-pcb} value in <i>Table 3: Thermal data</i> . Minor text changes.

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